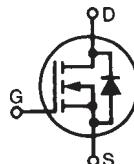


TrenchHV™ Power MOSFET

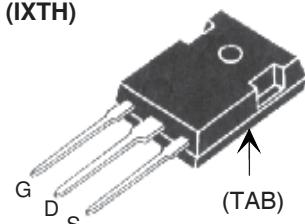
N-Channel Enhancement Mode
Avalanche Rated

IXTH96N25T
IXTQ96N25T
IXTV96N25T

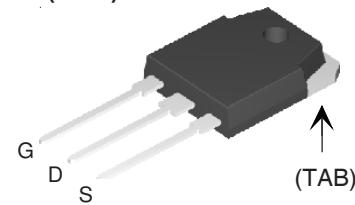


V_{DSS} = 250V
I_{D25} = 96A
R_{DS(on)} ≤ 29mΩ

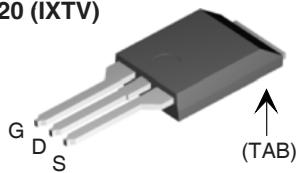
TO-247 (IXTH)



TO-3P (IXTQ)



PLUS220 (IXTV)



G = Gate D = Drain
S = Source TAB = Drain

Symbol	Test Conditions	Maximum Ratings	
V _{DSS}	T _J = 25°C to 150°C	250	V
V _{DGR}	T _J = 25°C to 150°C, R _{GS} = 1MΩ	250	V
V _{GSM}	Transient	± 30	V
I _{D25}	T _C = 25°C	96	A
I _{LRMS}	Lead Current Limit, RMS	75	A
I _{DM}	T _C = 25°C, pulse width limited by T _{JM}	250	A
I _{AS}	T _C = 25°C	5	A
E _{AS}	T _C = 25°C	2	J
P _D	T _C = 25°C	625	W
T _J		-55 ... +150	°C
T _{JM}		150	°C
T _{stg}		-55 ... +150	°C
T _L	1.6mm (0.062 in.) from case for 10s	300	°C
T _{SOLD}	Plastic body for 10 seconds	260	°C
M _d	Mounting torque (TO-247 & TO-3P)	1.13 / 10	Nm/lb.in.
F _c	Mounting force (PLUS220)	11..65 / 2.5..14.6	N/lb.
Weight	TO-247	6.0	g
	TO-3P	5.5	g
	PLUS220	4.0	g

Symbol	Test Conditions (T _J = 25°C unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
BV _{DSS}	V _{GS} = 0V, I _D = 250μA	250		V
V _{GS(th)}	V _{DS} = V _{GS} , I _D = 1mA	3		5 V
I _{GSS}	V _{GS} = ± 20V, V _{DS} = 0V		± 200	nA
I _{DSS}	V _{DS} = V _{DSS} V _{GS} = 0V	T _J = 125°C	5 μA 250 μA	
R _{DS(on)}	V _{GS} = 10V, I _D = 0.5 • I _{D25} , Notes 1, 2		29 mΩ	

Advantages

- Easy to mount

- Space savings

- High power density

Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor control
- Uninterruptible power supplies

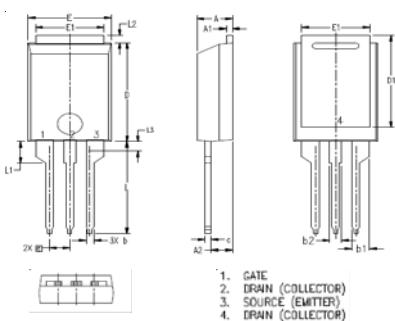
Symbol	Test Conditions	Characteristic Values		
	($T_J = 25^\circ\text{C}$ unless otherwise specified)	Min.	Typ.	Max.
g_{fs}	$V_{DS} = 10\text{V}$, $I_D = 0.5 \cdot I_{D25}$, Note 1	50	82	S
C_{iss}		6100		pF
C_{oss}		625		pF
C_{rss}		75		pF
$t_{d(on)}$		20		ns
t_r		22		ns
$t_{d(off)}$		59		ns
t_f	Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 0.5 \cdot I_{D25}$ $R_G = 2.5\Omega$ (External)	28		ns
$Q_{g(on)}$		114		nC
Q_{gs}		33		nC
Q_{gd}		34		nC
R_{thJC}			0.20	°C/W
R_{thCS}		0.25		°C/W

Source-Drain Diode

Symbol	Test Conditions	Characteristic Values		
	($T_J = 25^\circ\text{C}$ unless otherwise specified)	Min.	Typ.	Max.
I_s	$V_{GS} = 0\text{V}$		96	A
I_{SM}	Repetitive, pulse width limited by T_{JM}		300	A
V_{SD}	$I_F = I_S$, $V_{GS} = 0\text{V}$, Note 1		1.5	V
t_{rr}		158		ns
I_{RM}	$I_F = 48\text{A}$, $-di/dt = 250\text{ A}/\mu\text{s}$	23		A
Q_{RM}	$V_R = 100\text{ V}$, $V_{GS} = 0\text{V}$	1.8		μC

- Notes:
1. Pulse test, $t \leq 300\text{ms}$; duty cycle, $d \leq 2\%$.
 2. On through-hole packages, $R_{DS(on)}$ Kelvin test contact location must be 5 mm or less from the package body.

PLUS220 (IXTV) Outline



SYM	INCHES		MILLIMETER	
	MIN	MAX	MIN	MAX
A	.169	.185	4.30	4.70
A1	.028	.035	0.70	0.90
A2	.098	.118	2.50	3.00
b	.035	.047	0.90	1.20
b1	.080	.095	2.03	2.41
b2	.054	.064	1.37	1.63
c	.028	.035	0.70	0.90
D	.551	.591	14.00	15.00
D1	.512	.539	13.00	13.70
E	.394	.433	10.00	11.00
E1	.331	.346	8.40	8.80
e	.100	BSC	2.54	BSC
L	.512	.551	13.00	14.00
L1	.118	.138	3.00	3.50
L2	.035	.051	0.90	1.30
L3	.047	.059	1.20	1.50

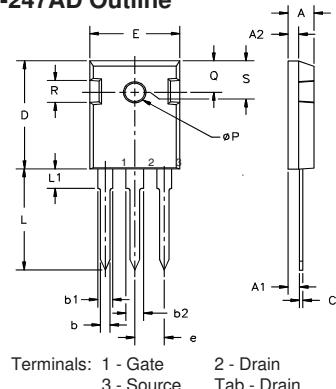
PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS reserves the right to change limits, test conditions, and dimensions.

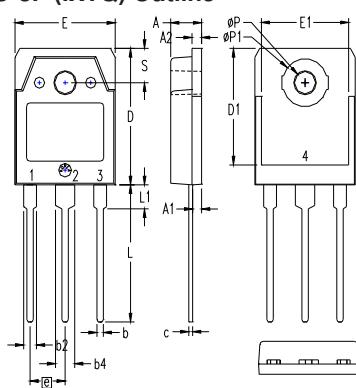
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

TO-247AD Outline



Dim.	Millimeter Min.	Max.	Inches Min.	Max.
A	4.7	5.3	.185	.209
A ₁	2.2	2.54	.087	.102
A ₂	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b ₁	1.65	2.13	.065	.084
b ₂	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	.205	.225
L	19.81	20.32	.780	.800
L ₁		4.50		.177
AEP	3.55	3.65	.140	.144
Q	5.89	6.40	.232	.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC

TO-3P (IXTQ) Outline

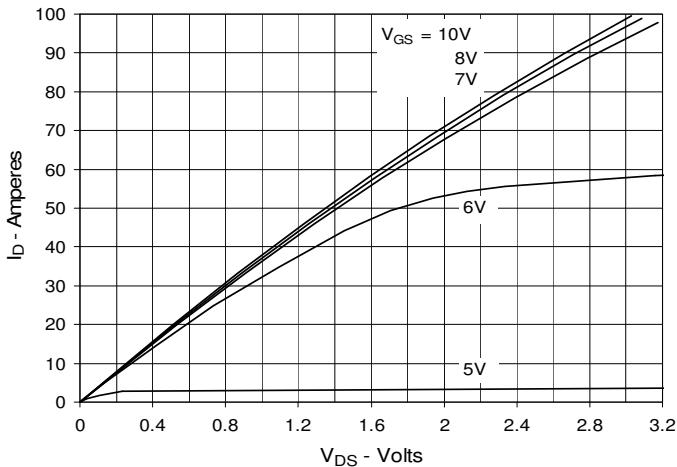


Pins: 1 - Gate 2 - Drain
3 - Source 4, TAB - Drain

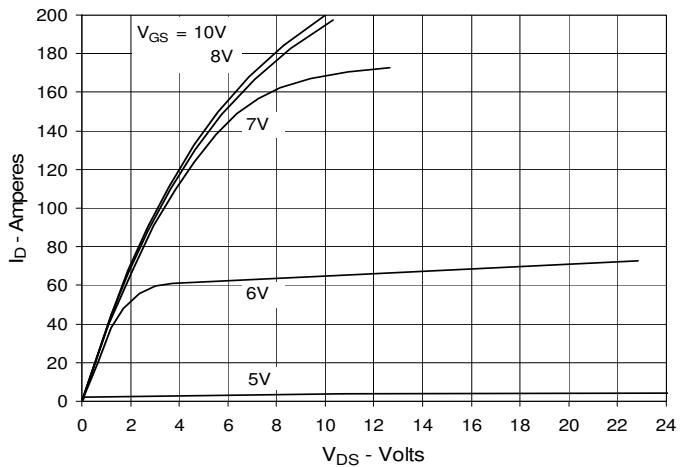
SYM	INCHES	MILLIMETERS
A	.185	.49
A1	.051	.130
A2	.057	.145
b	.035	.089
b2	.075	.190
b4	.114	.290
c	.022	.055
D	.780	.1980
D1	.665	.1690
E	.610	.1550
E1	.531	.1350
e	.215	.545
L	.779	.1980
L1	.134	.340
P	.126	.320
P1	.272	.690
S	.193	.490

All metal areas are tin plated.

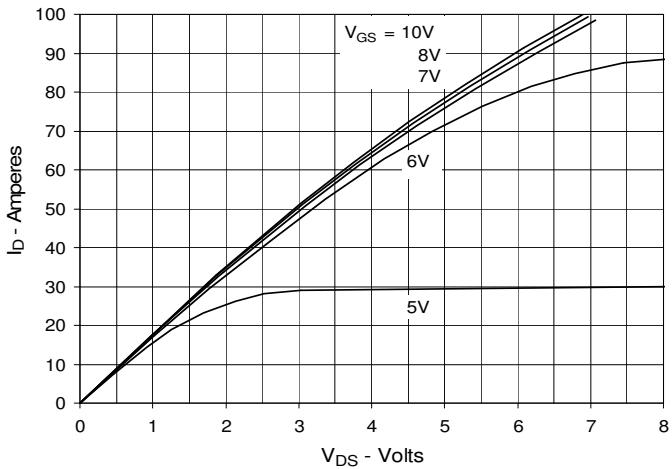
**Fig. 1. Output Characteristics
@ 25°C**



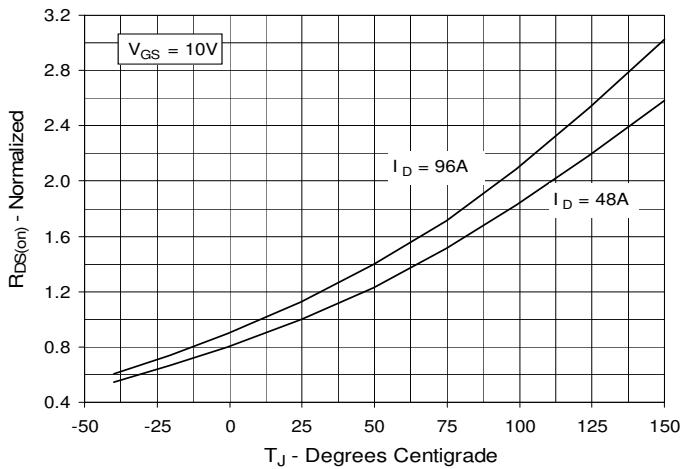
**Fig. 2. Extended Output Characteristics
@ 25°C**



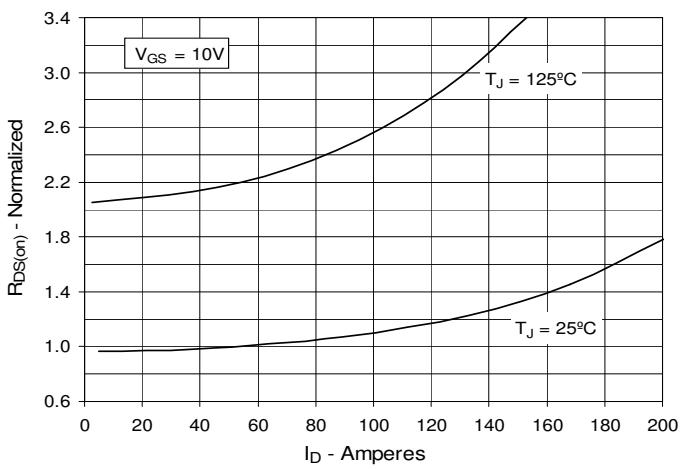
**Fig. 3. Output Characteristics
@ 125°C**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 48A$ Value
vs. Junction Temperature**



**Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 48A$ Value
vs. Drain Current**



**Fig. 6. Maximum Drain Current vs.
Case Temperature**

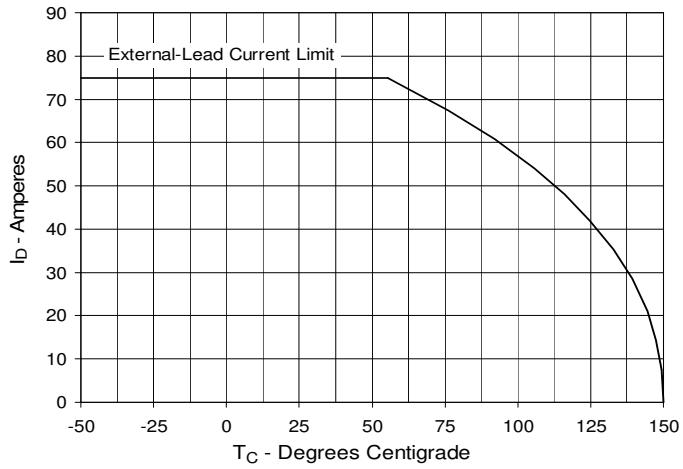
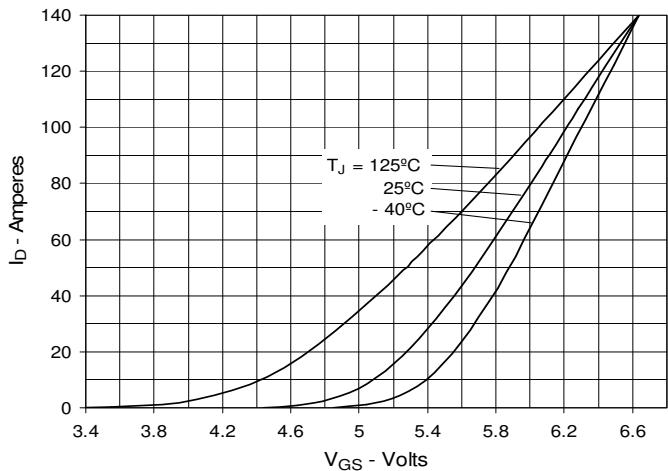
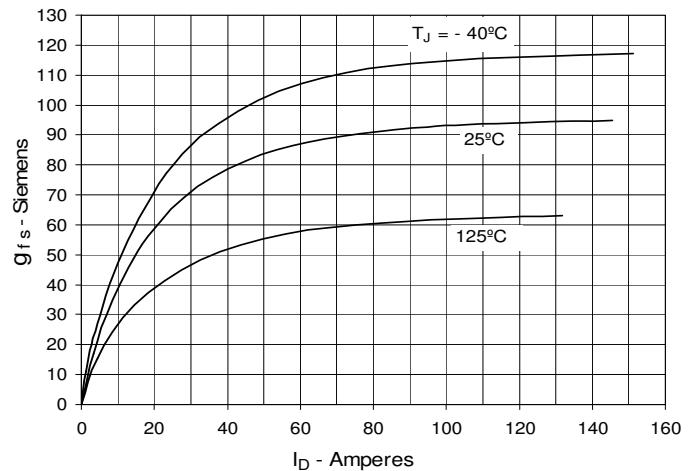
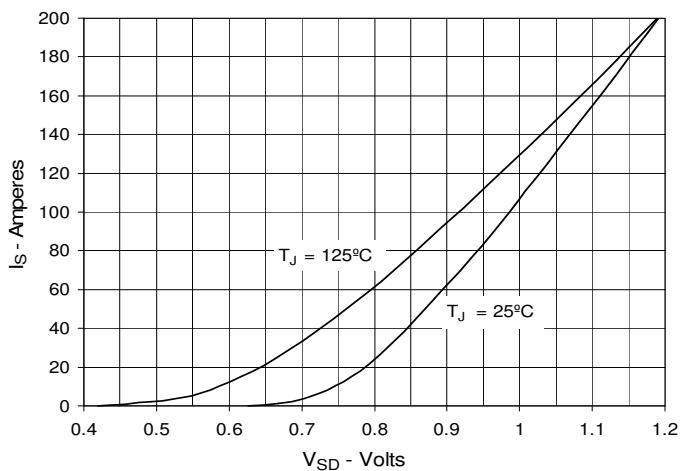
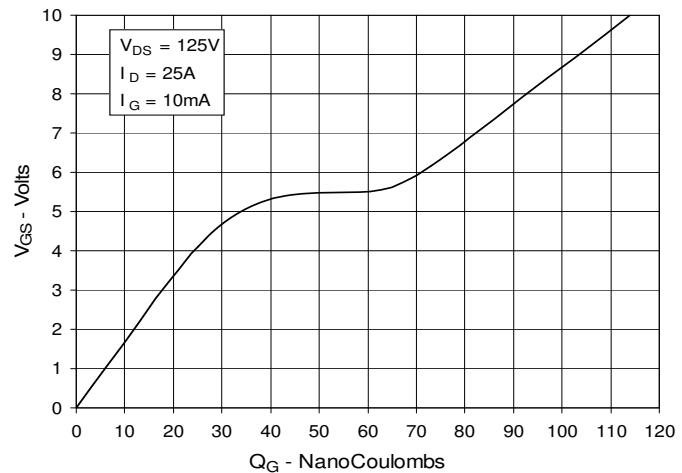
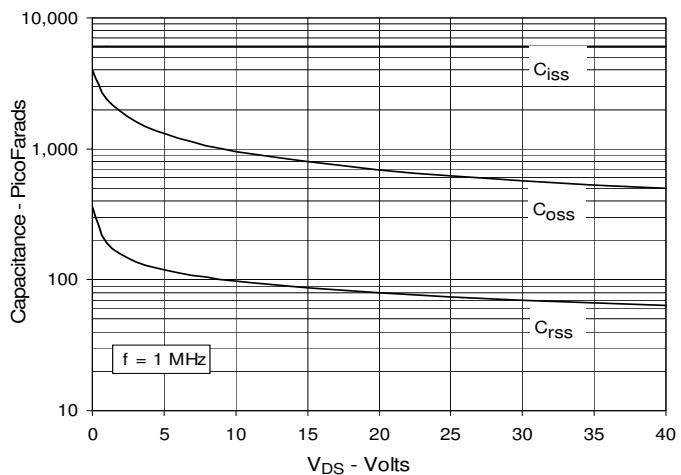
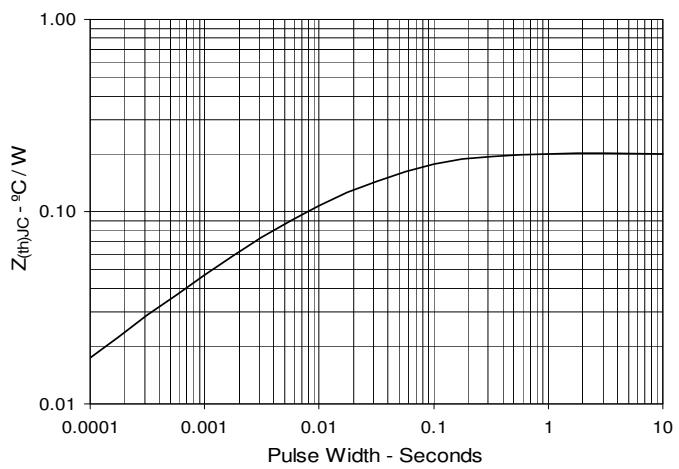
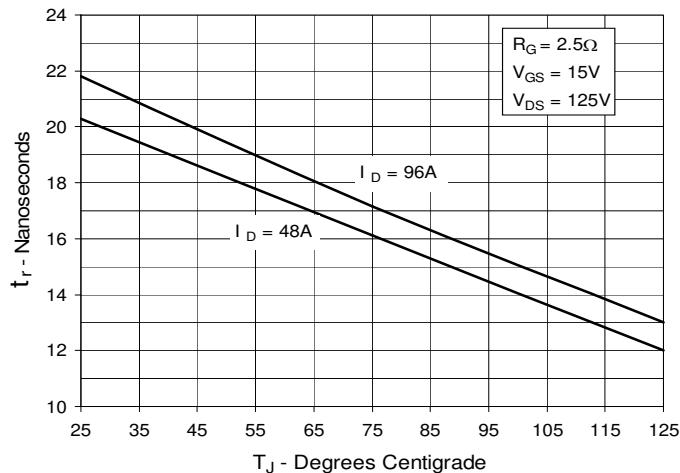
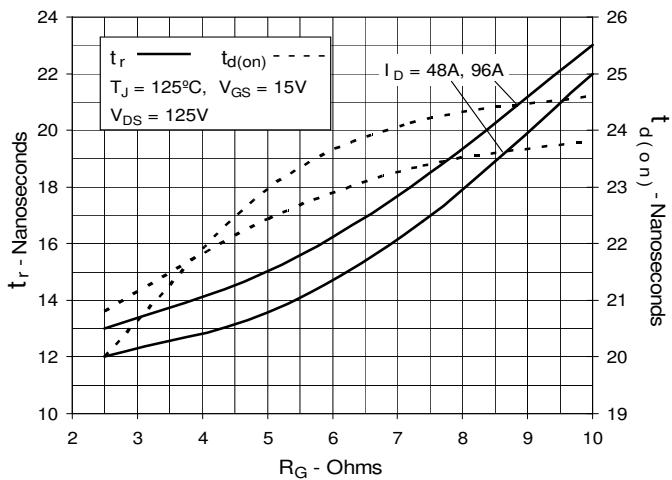


Fig. 7. Input Admittance

Fig. 8. Transconductance

Fig. 9. Forward Voltage Drop of Intrinsic Diode

Fig. 10. Gate Charge

Fig. 11. Capacitance

Fig. 12. Maximum Transient Thermal Impedance


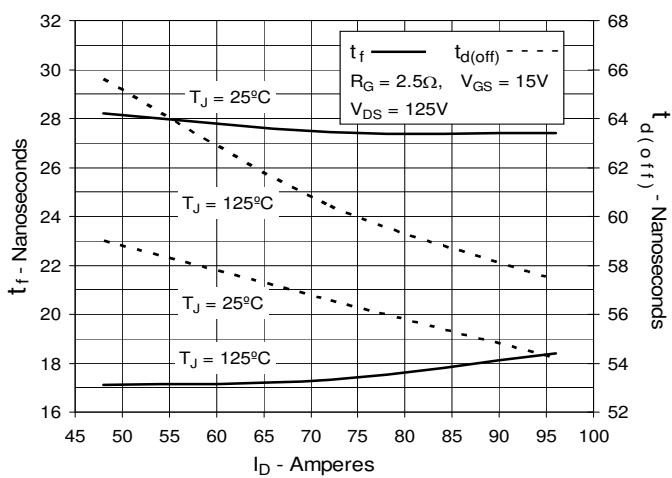
**Fig. 13. Resistive Turn-on
Rise Time vs. Junction Temperature**



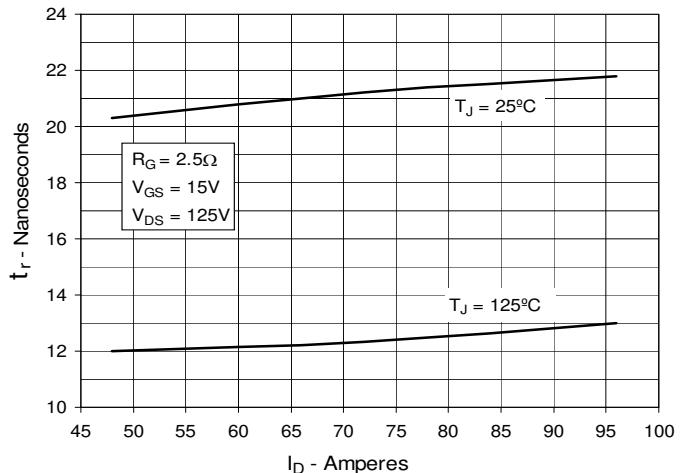
**Fig. 15. Resistive Turn-on
Switching Times vs. Gate Resistance**



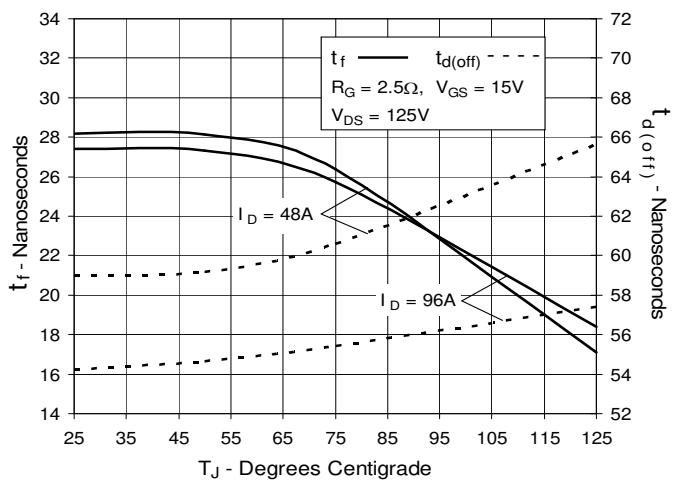
**Fig. 17. Resistive Turn-off
Switching Times vs. Drain Current**



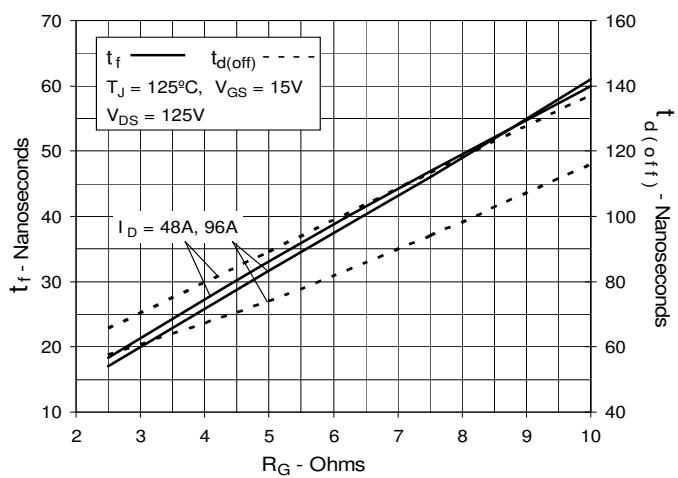
**Fig. 14. Resistive Turn-on
Rise Time vs. Drain Current**



**Fig. 16. Resistive Turn-off
Switching Times vs. Junction Temperature**



**Fig. 18. Resistive Turn-off
Switching Times vs. Gate Resistance**





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